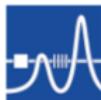


Tracking Detector for Luminosity Measurement at PANDA

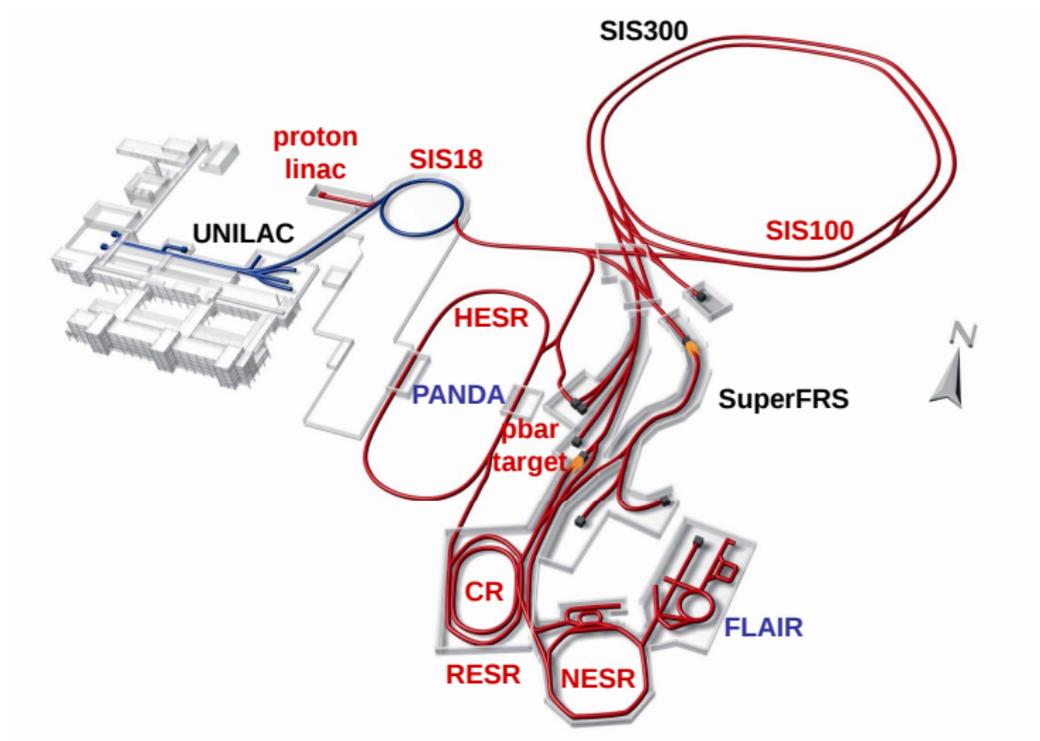
Christof Motzko
on behalf of the PANDA Luminosity Detector Group

Helmholtz-Institut Mainz
Johannes Gutenberg-Universität Mainz

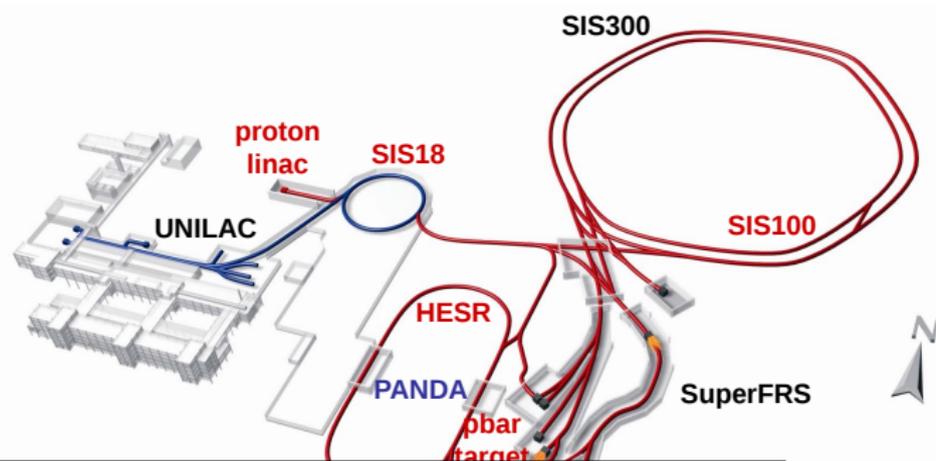
February 28, 2017
Instrumentation for Colliding Beam Physics (INSTR-17)



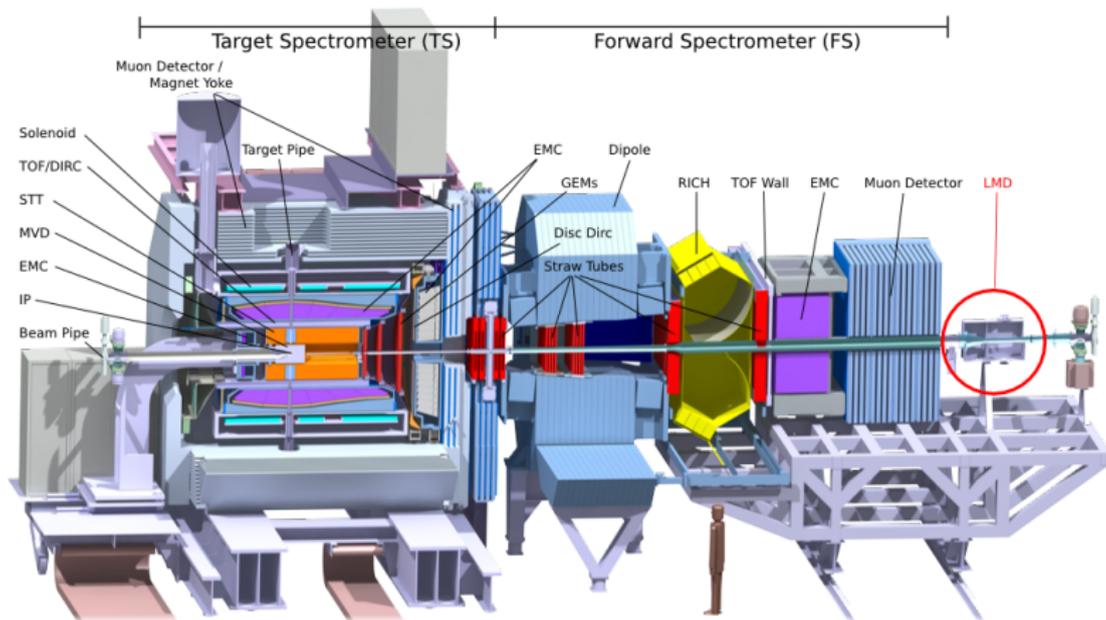
FAIR - Facility for Antiproton and Ion Research



FAIR - Facility for Antiproton and Ion Research



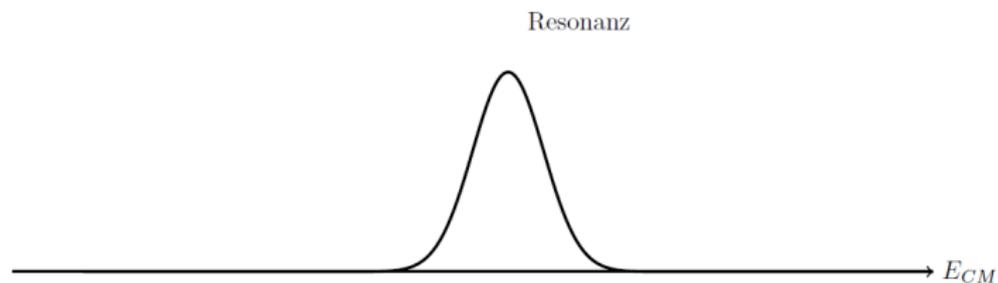
	High Luminosity	High Resolution
Antiproton p	1.5 – 15 GeV/c	1.5 – 8.9 GeV/c
N Antiprotons	10^{11}	10^{10}
Luminosity	$2 \cdot 10^{32} \text{ cm}^{-2} \text{ s}^{-1}$	$2 \cdot 10^{31} \text{ cm}^{-2} \text{ s}^{-1}$
$\Delta p/p$	10^{-4}	10^{-5}



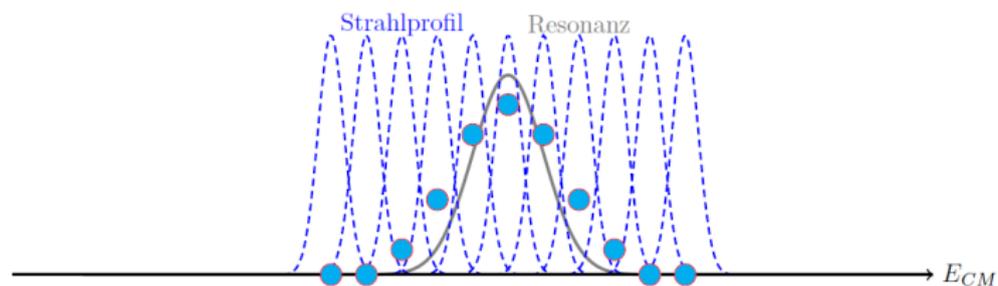
Physics at PANDA

- Hadron spectroscopy
- Hadron structure
- Hadron in medium
- Hypernuclear physics

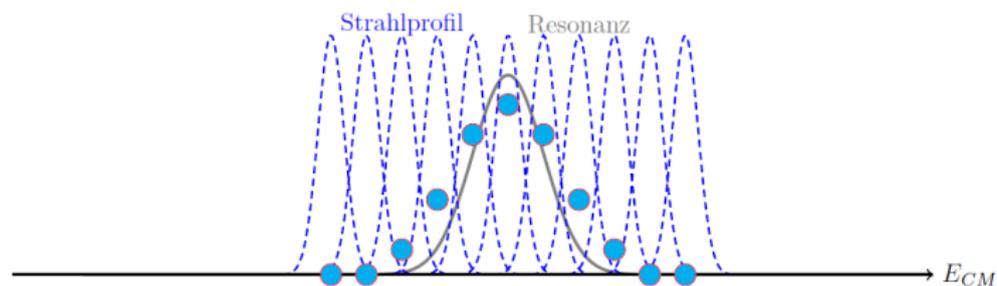
Measurement of Line Shape via Energy Scan



Measurement of Line Shape via Energy Scan



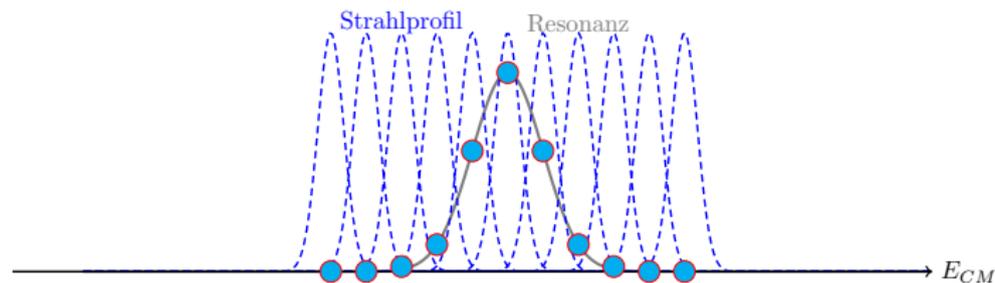
Measurement of Line Shape via Energy Scan



Normalization required:

$$\frac{\Delta N}{\Delta t} = \mathcal{L} \cdot \sigma$$

Measurement of Line Shape via Energy Scan



Normalization required:

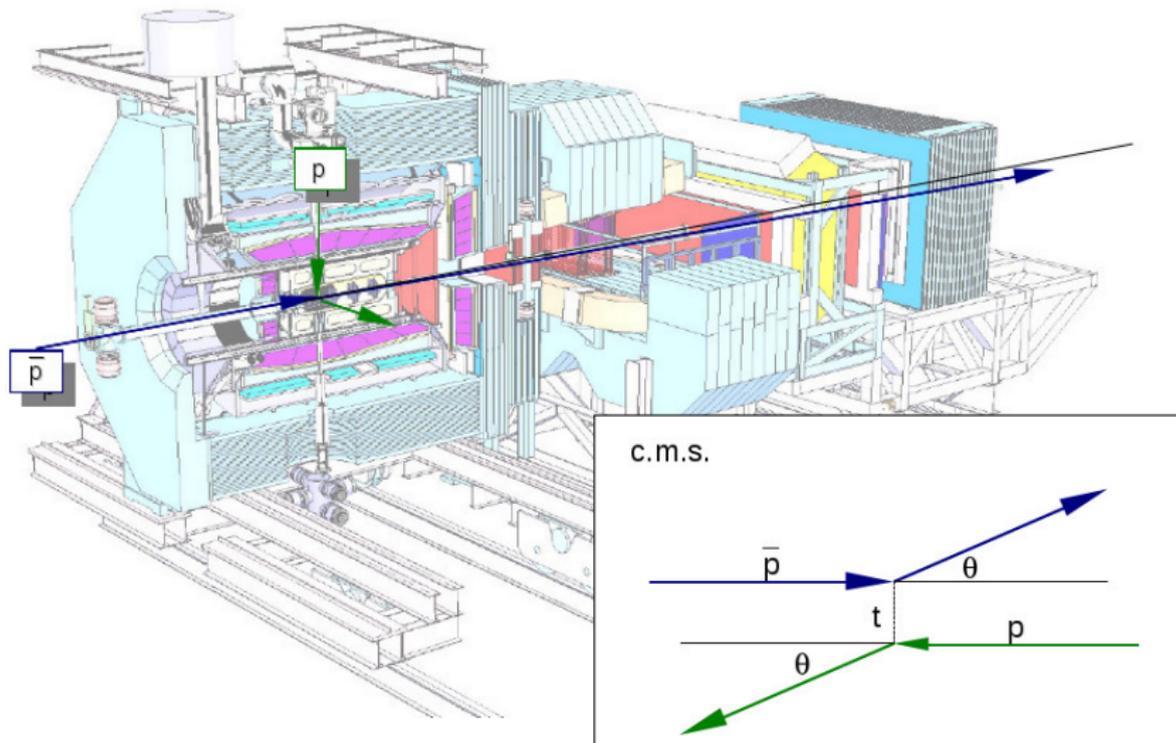
$$\frac{\Delta N}{\Delta t} = \mathcal{L} \cdot \sigma$$

$$\Rightarrow \mathcal{L} = \frac{\Delta N}{\Delta t} \cdot \frac{1}{\sigma}$$

$$\Rightarrow \mathcal{L} = \frac{\Delta N}{\Delta t} \cdot \frac{1}{\sigma}$$

aimed resolution:	absolute	$\frac{\Delta \mathcal{L}}{\mathcal{L}} < 5\%$
	relative	$\frac{\Delta \mathcal{L}}{\mathcal{L}} < 1\%$

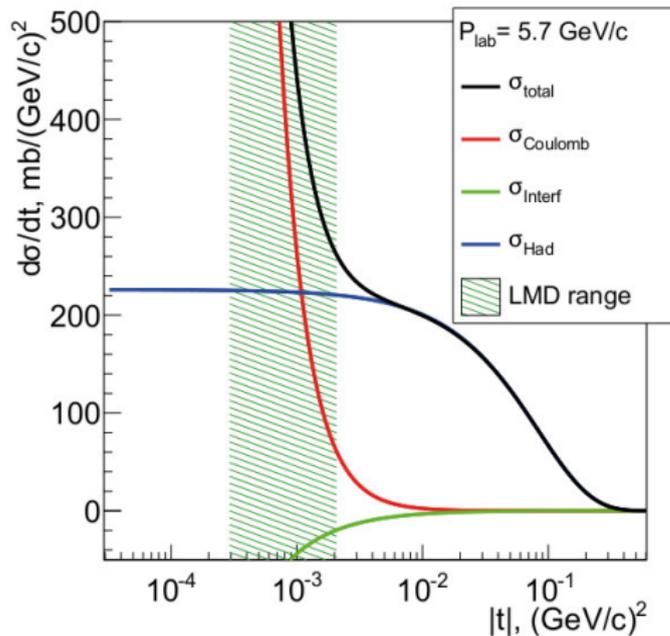
Elastic Scattering in PANDA



Measurement of elastic scattered antiprotons with $\Theta = 3 - 8 \text{ mrad}$

Elastic Scattering

PANDA: Measurement of elastic scattered antiprotons



At small $|t|$

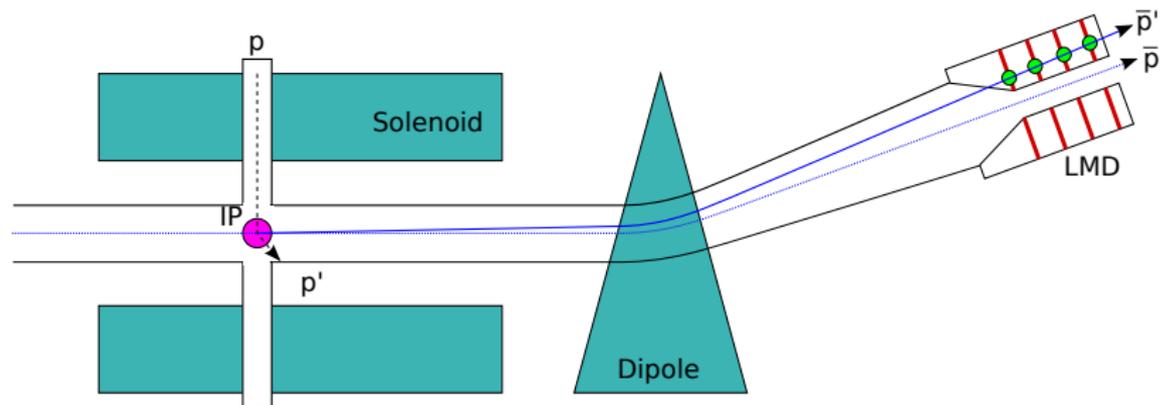
- Coulomb scattering dominates
- Differential cross section can be calculated

At larger $|t|$

- Hadronic part dominates
- Description by models using data
- Large uncertainties of the model

$$\frac{d\sigma_{el}}{dt} = \frac{d\sigma_{coul}}{dt} + \frac{d\sigma_{hadr}}{dt} + \frac{d\sigma_{int}}{dt}$$

Particle Track Reconstruction



Requirements:

Luminosity Measurement

- Measurement at small angles
- High angular resolution
 - very precise
 - minimal material

Requirements:

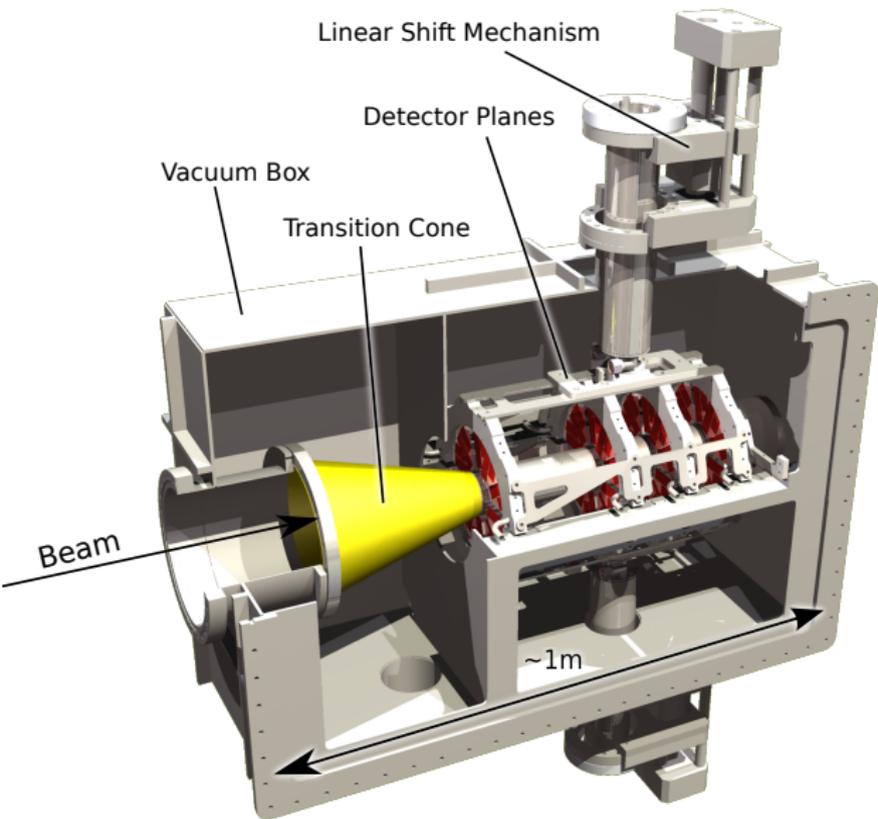
Luminosity Measurement

- Measurement at small angles
- High angular resolution
 - very precise
 - minimal material

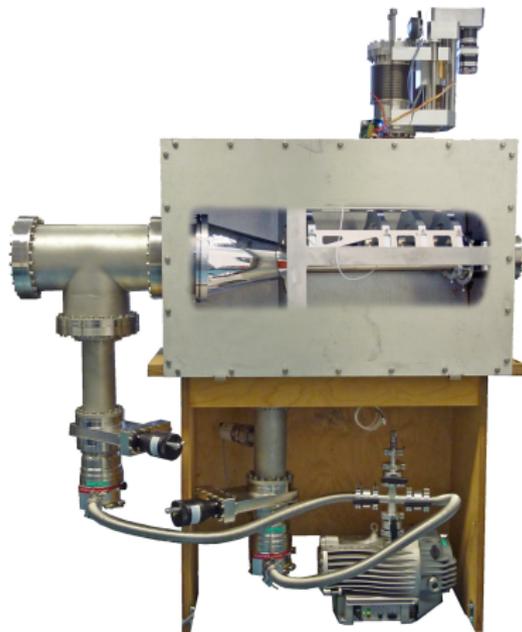
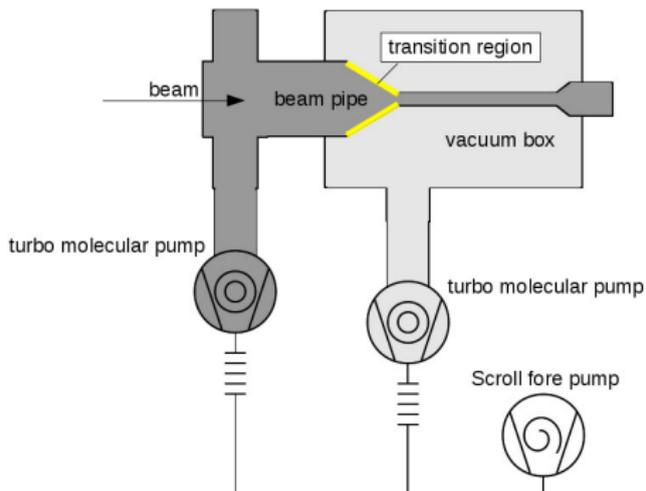
Storage Ring

- High vacuum $< 10^{-9}$ mbar
- Slow changes of beam pipe diameter $< 15^\circ$
- Minimal distortion of the beam

Luminosity Detector Overview



Differential Pumping Scheme



Vacuum to reduce multiple scattering of antiprotons

⇒ Thin transition foil required to:

- Not disturb UHV of the beam pipe
- Not disturb the antiproton beam

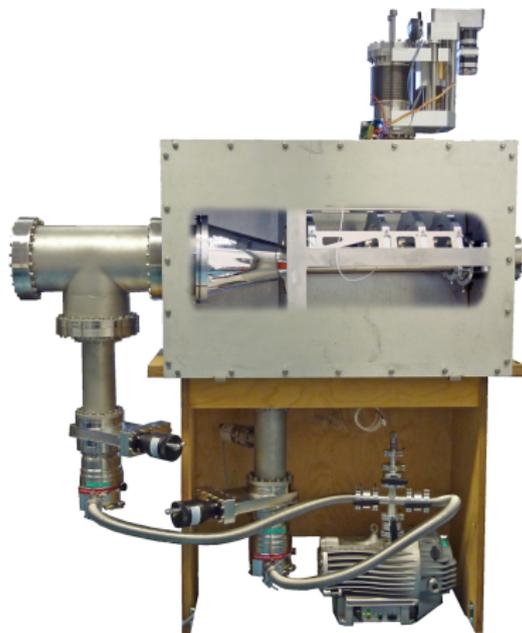
Differential Pumping Scheme

Requirements:

- Beam pipe: 10^{-9} mbar
- Vacuum box: 10^{-6} mbar

First test results:

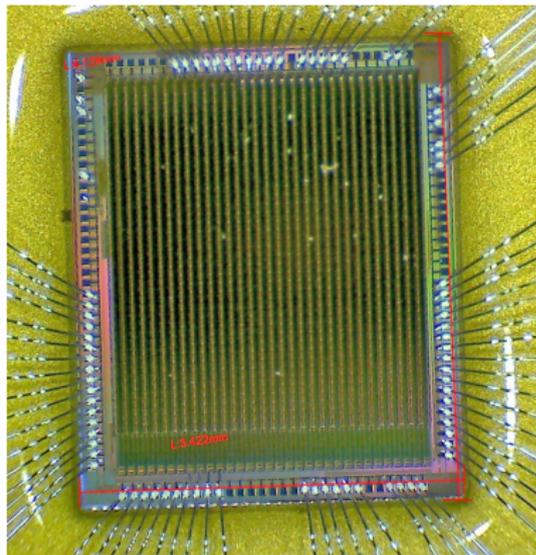
- Beam pipe: $6 \cdot 10^{-8}$ mbar
- Vacuum box: $4 \cdot 10^{-7}$ mbar



- High Voltage Monolithic Active Pixel Sensor
- Under development (Mu3e group in Heidelberg)
Status of the Mu3e detector: Dirk Wiedner 4:00 pm
- Standard CMOS production
- Digital part on chip
- High bias voltage increases S/N
- Pixel size: $80\ \mu\text{m} \times 80\ \mu\text{m}$
- Thickness: $\sim 50\ \mu\text{m}$

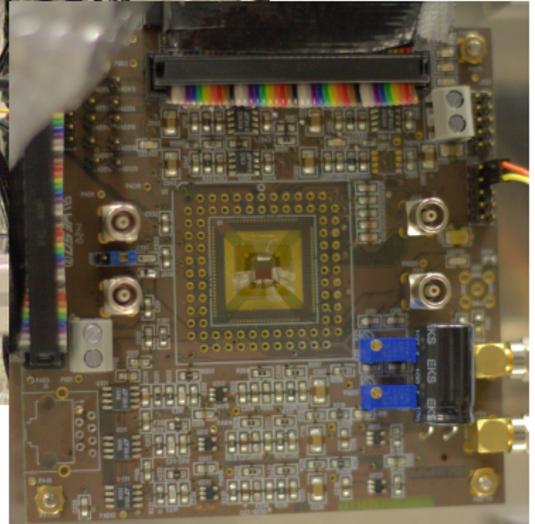
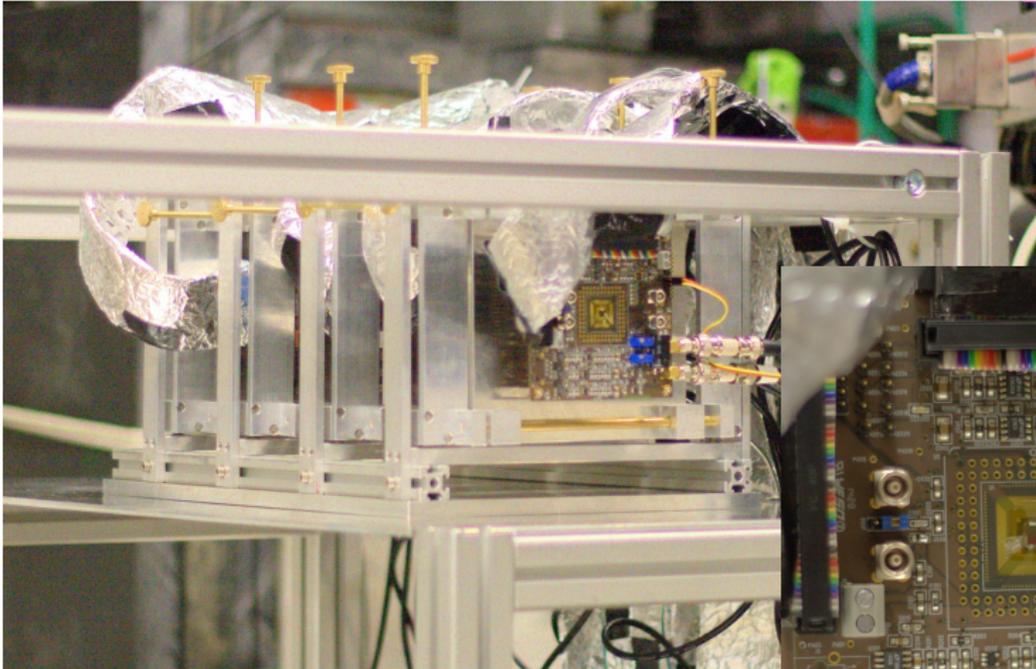
- Dimensions: $\sim 2 \times 2\ \text{cm}^2$
- Expected power consumption $< 300\ \text{mW}/\text{cm}^2$

MuPix 4 prototype $3 \times 4\ \text{mm}^2$

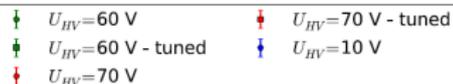
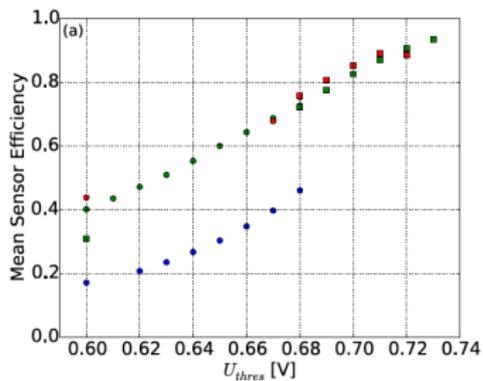


Test Beam at MAMI

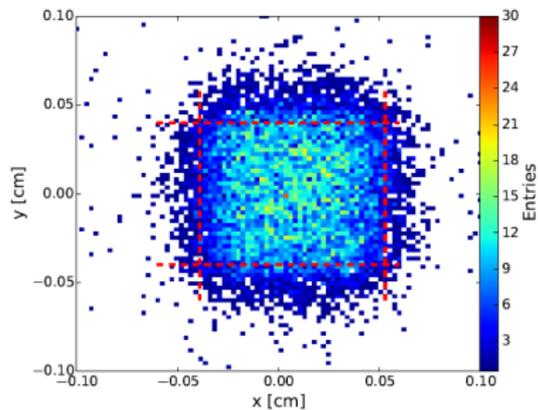
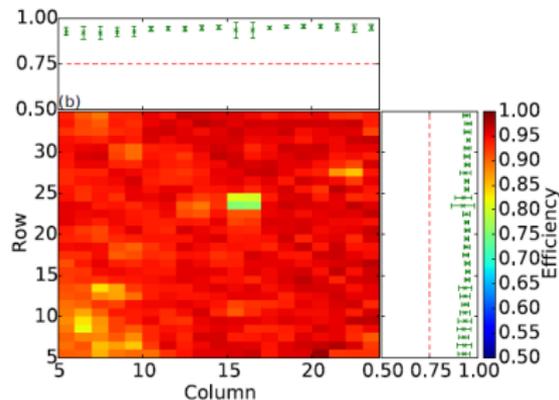
Test beam with a HV-MAPS (MuPix6) tracking station



Results



- Efficiency: $> 99\%$
- Expected noise rate: 0.12 MHz per sensor $\Rightarrow \sim 1$ noise hit per timeframe
- Hit resolution given by pixel cell size
- Time resolution: 7 ns



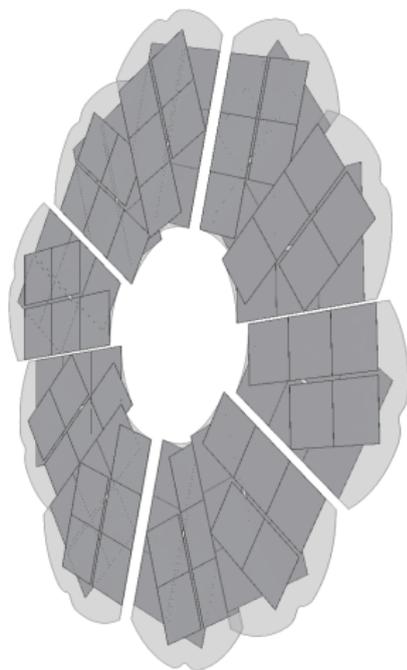
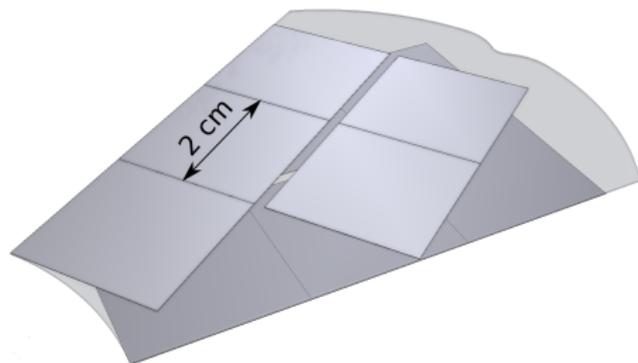
Arrangement of HV-MAPS

400 sensors ($50\ \mu\text{m}$ thick) glued on 40 CVD diamond wafers

- 4 planes with 10 modules
- Full azimuthal range

Advantages of CVD diamond:

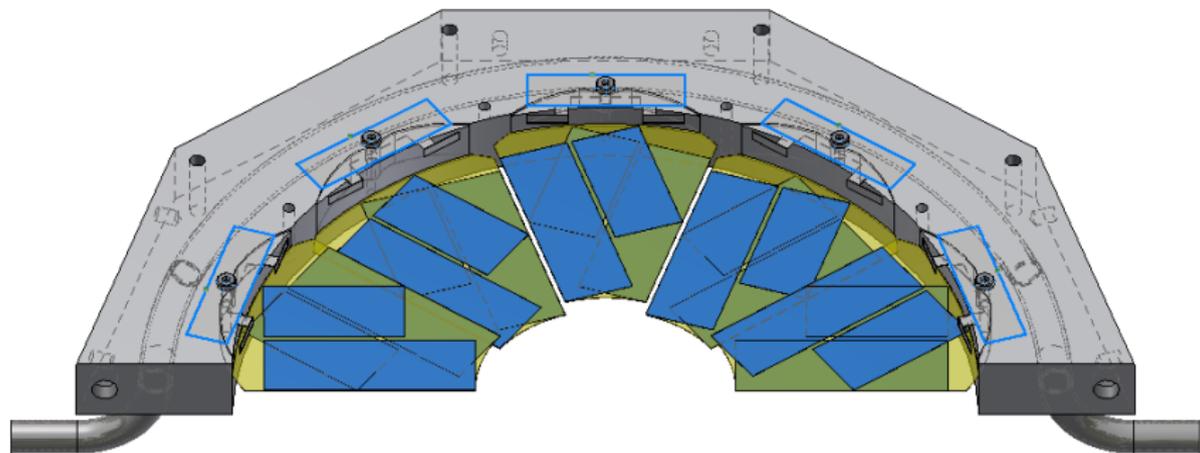
- very high thermal conductivity
- very hard material
⇒ very thin supply structure ($200\ \mu\text{m}$)



Support Structure

Modules clamped to a support structure

- V2A pipe melted inside aluminum structure
- Cooling of sensors and electronic

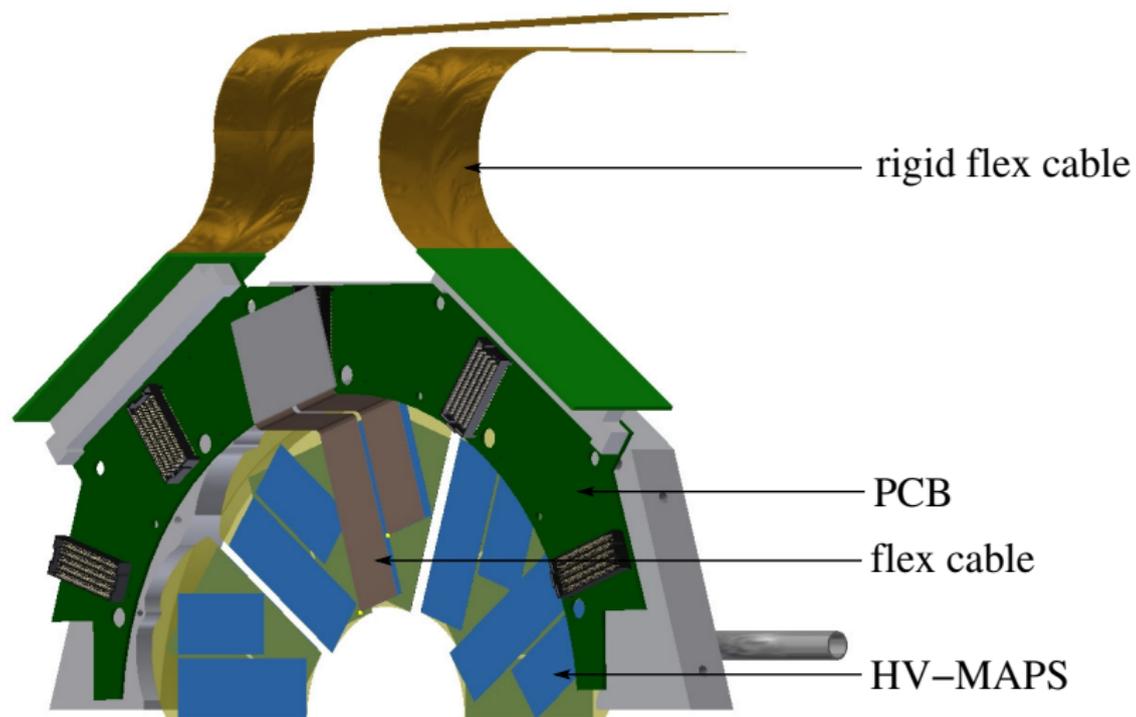


Support Structure

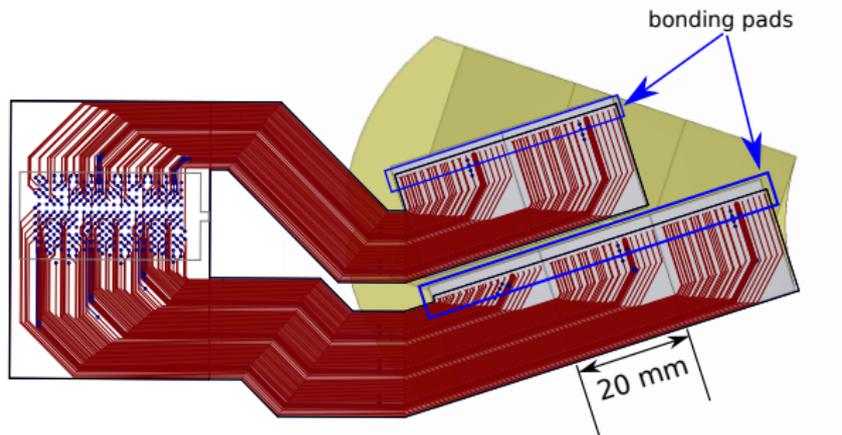
Modules clamped to a support structure

- V2A pipe melted inside aluminum structure
- Cooling of sensors and electronic



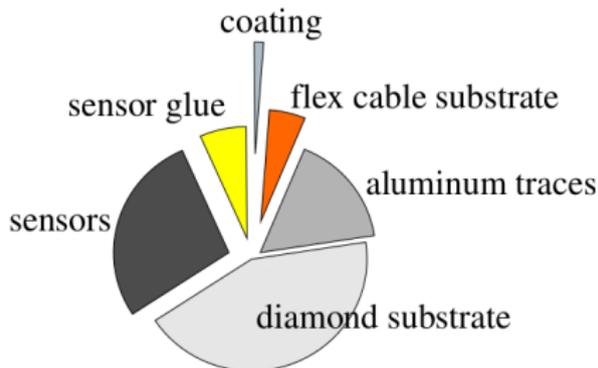


Connection of HV-MAPS

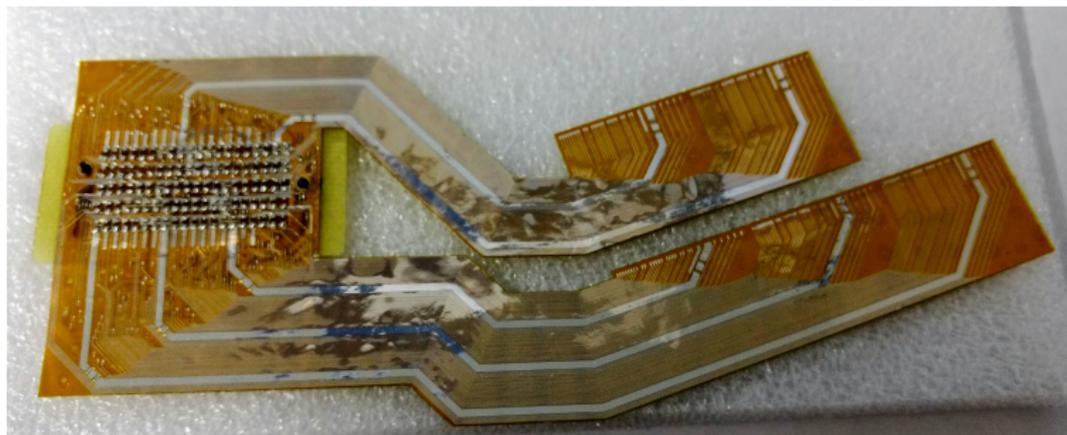


Average $X/X_0 = 0.32\%$
 $\approx 350\ \mu\text{m}$ silicon

With copper traces:
Average $X/X_0 = 0.55\%$

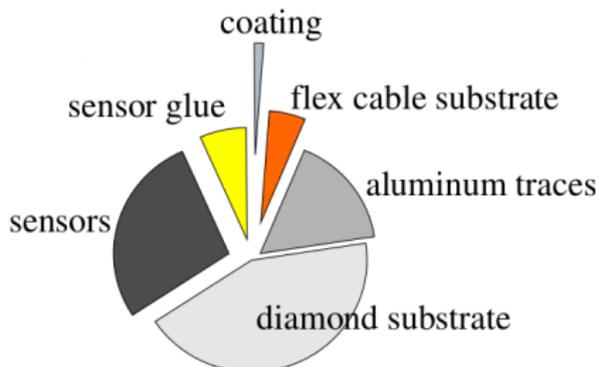


Connection of HV-MAPS

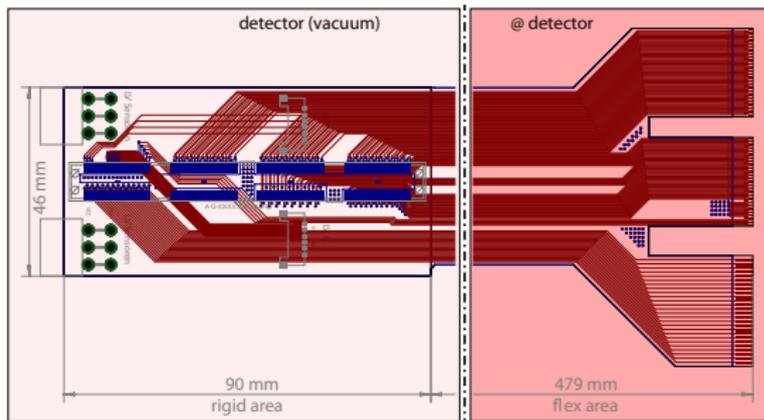


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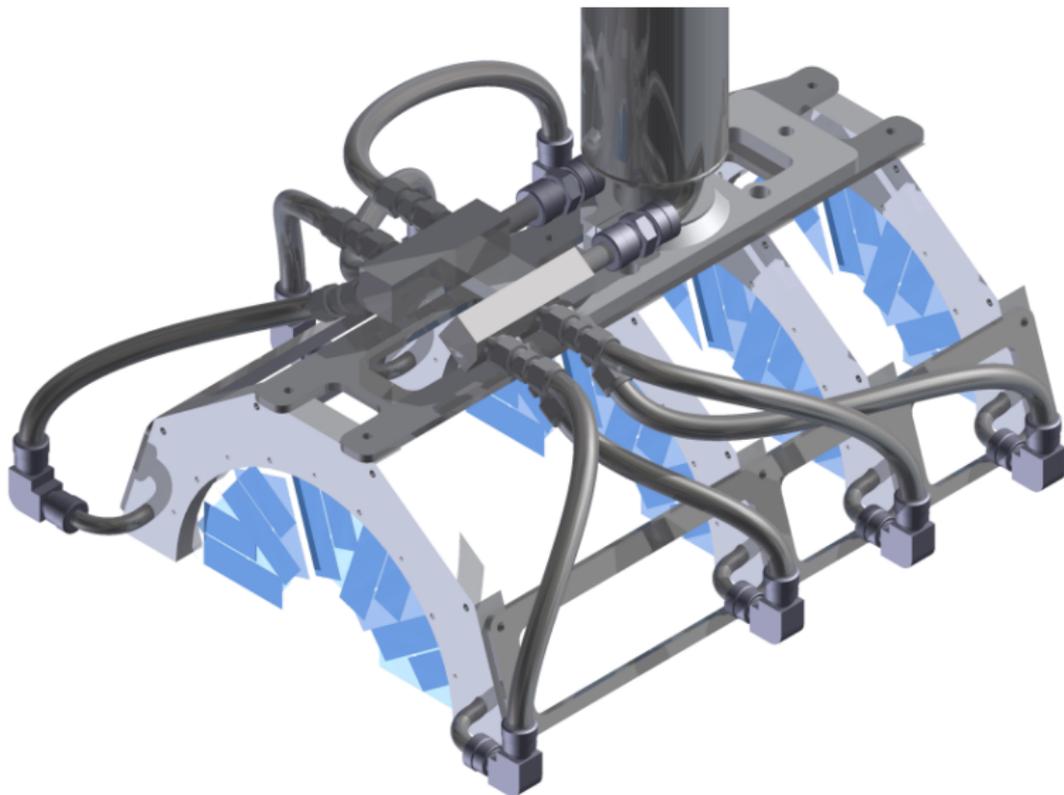


Rigid Flex Cable



- FFC connector outside of the box
- Three layers for flex area:
 - 40 differential pairs (signal, clock, ...)
 - High voltage



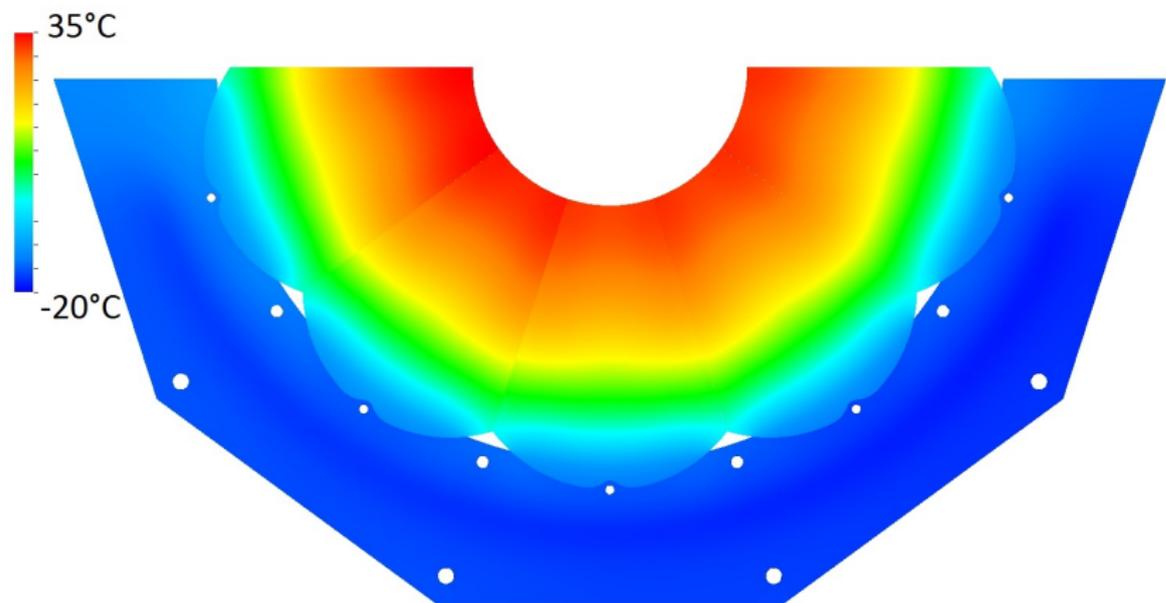


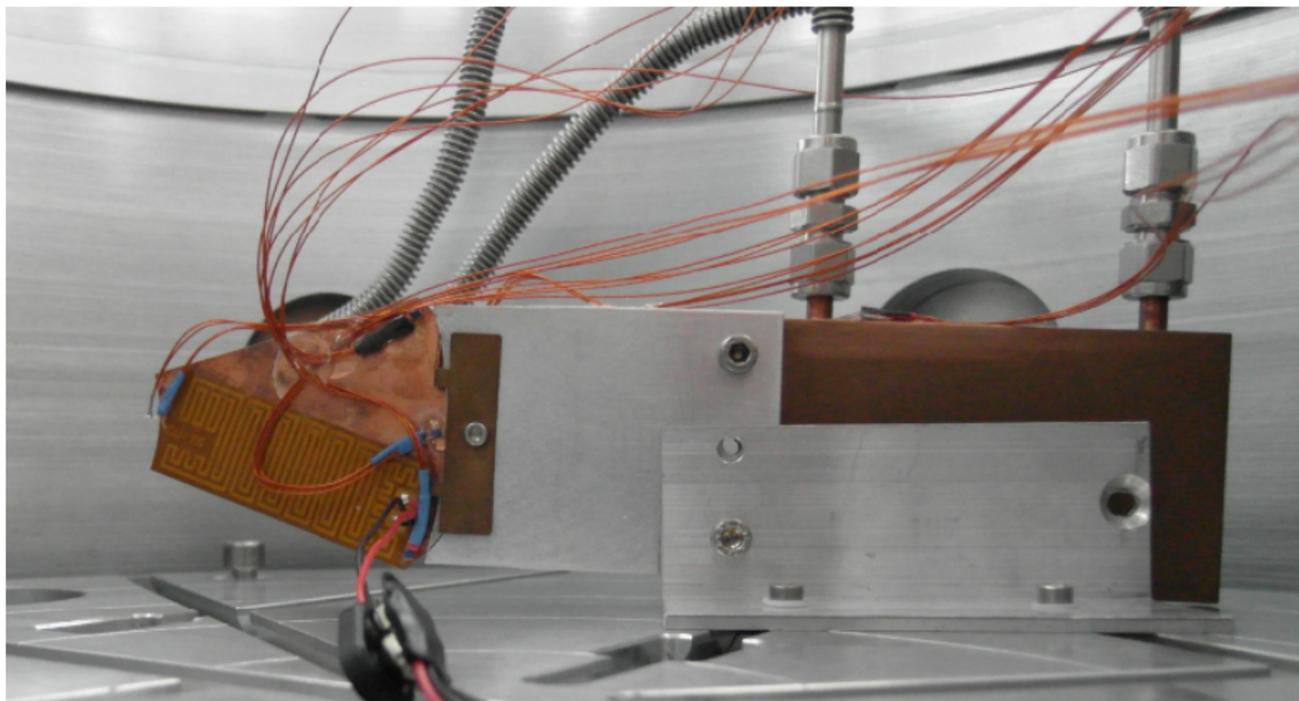
Simulations on Cooling

Simulation with up to 700 W/cm^2 and power dissipating electronics

Expected heat per half plane:

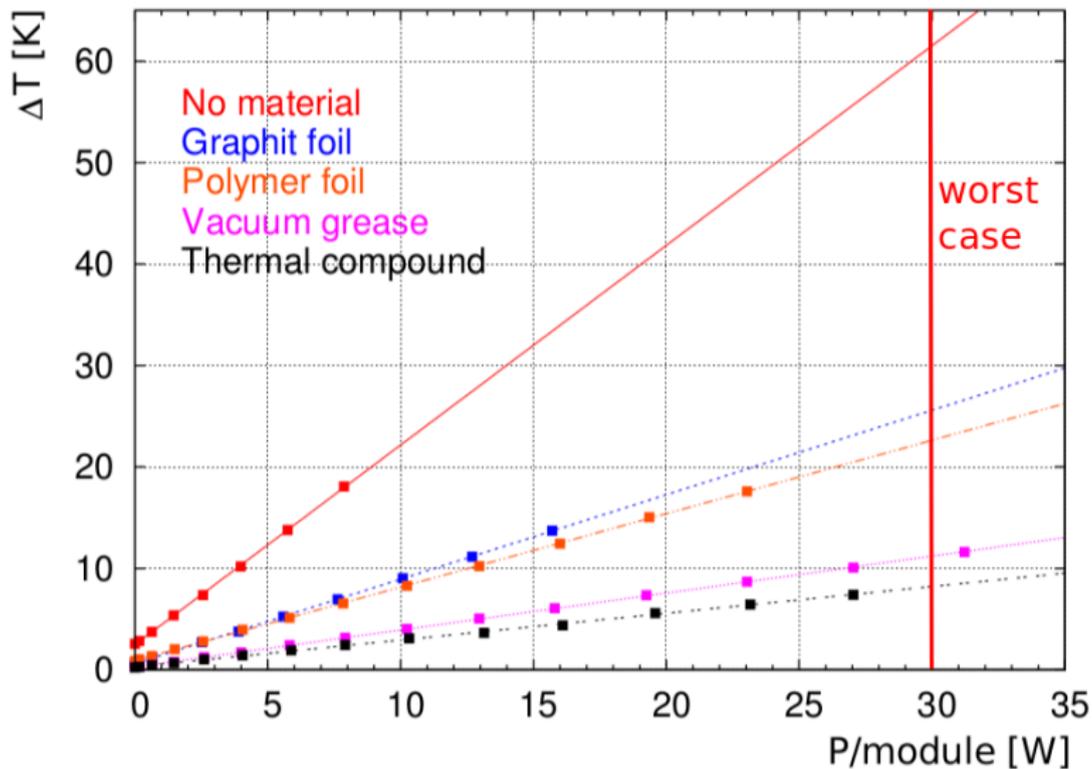
- Sensors: 140 W
- Electronics: 110 W



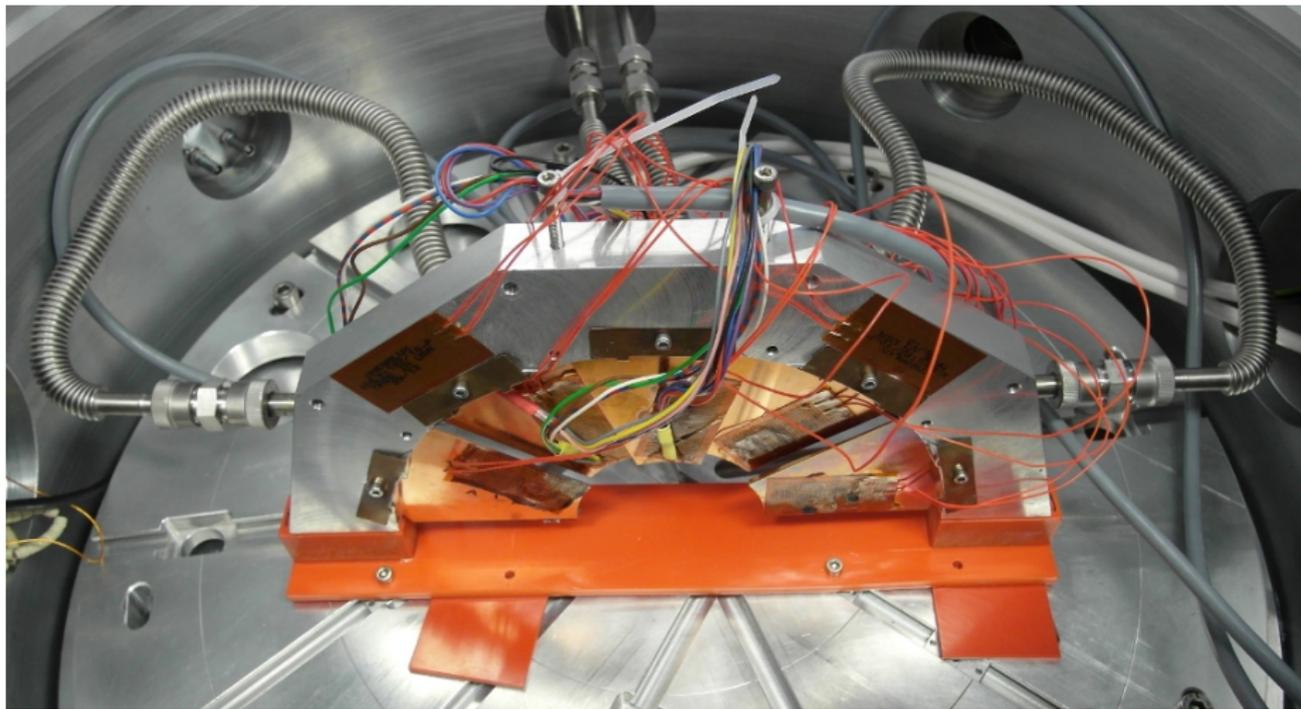


Testing of contact materials with a module clamp and a copper dummy

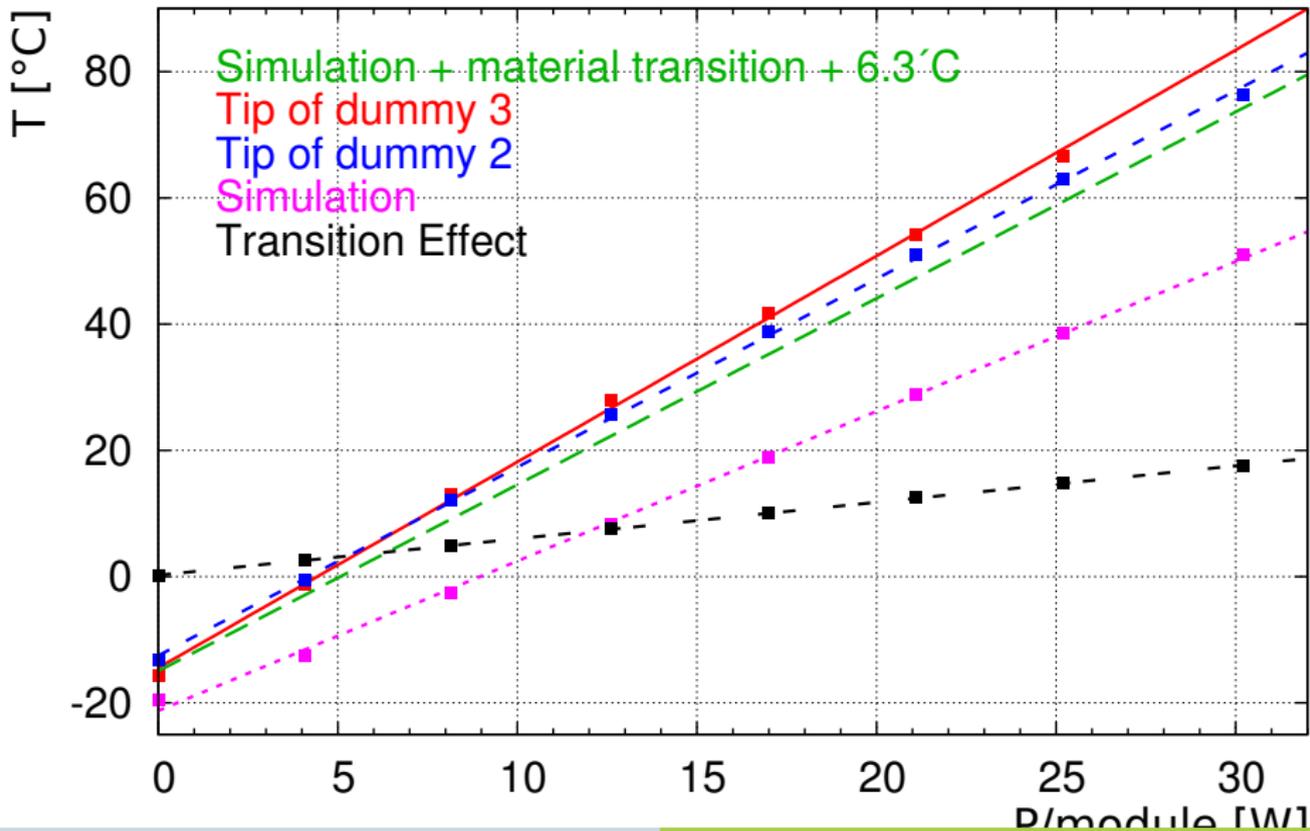
Contact Materials



Cooling Tests in Vacuum



Cooling Tests in Vacuum



Online

- Expected data rate: $> 5.5 \text{ TB/d}$
⇒ Online selection necessary
- Use of Cellular Automaton for track reconstruction
- Calculation on GPUs

Poster: Data acquisition for the PANDA luminosity detector with online track reconstruction: Stephan Maldaner 5:00 pm

Offline

- Use of Cellular Automaton and Track Follower for track reconstruction
 - Missed tracks $< 1\%$
 - Fake tracks $< 1\%$
- Precision for luminosity determination below % with realistic scenarios
- All beam influences can be corrected
 - IP distribution
 - IP displacement
 - Beam tilt
 - Beam divergence

Conclusion

- Design is ready
- Software completed
- TDR finished

To Do

Development of assembly procedure:

- Test of glueing of thin sensors
- Positioning of the sensors
- Mounting of the modules and half planes

Radiation test of all electronic components

Test of the flex cables

Test of full cooling circuit at full load

Online Software

Prototype is under the way